



DRV5053 Analog-Bipolar Hall Effect Sensor

1 Features

- Linear Output Hall Sensor
- Superior Temperature Stability
 - Sensitivity $\pm 10\%$ Over Temperature
- High Sensitivity Options:
 - -11 mV/mT (OA, See [Figure 17](#))
 - -23 mV/mT (PA)
 - -45 mV/mT (RA)
 - -90 mV/mT (VA)
 - $+23$ mV/mT (CA)
 - $+45$ mV/mT (EA)
- Supports a Wide Voltage Range
 - 2.5 to 38 V
 - No External Regulator Required
- Wide Operating Temperature Range
 - $T_A = -40$ to 125°C (Q, See [Figure 17](#))
- Amplified Output Stage
 - 2.3-mA Sink, 300 μA Source
- Output Voltage: 0.2 ~ 1.8 V
 - $B = 0$ mT, $\text{OUT} = 1$ V
- Fast Power-On: 35 μs
- Small Package and Footprint
 - Surface Mount 3-Pin SOT-23 (DBZ)
 - 2.92 mm \times 2.37 mm
 - Through-Hole 3-Pin TO-92 (LPG)
 - 4.00 mm \times 3.15 mm
- **Protection Features**
 - Reverse Supply Protection (up to -22 V)
 - Supports up to 40-V Load Dump
 - Output Short-Circuit Protection
 - Output Current Limitation

2 Applications

- Flow Meters
- Docking Adjustment
- Vibration Correction
- Damper Controls

3 Description

The DRV5053 device is a chopper-stabilized Hall IC that offers a magnetic sensing solution with superior sensitivity stability over temperature and integrated protection features.

The 0- to 2-V analog output responds linearly to the applied magnetic flux density, and distinguishes the polarity of magnetic field direction. A wide operating voltage range from 2.5 to 38 V with reverse polarity protection up to -22 V makes the device suitable for a wide range of industrial and consumer applications.

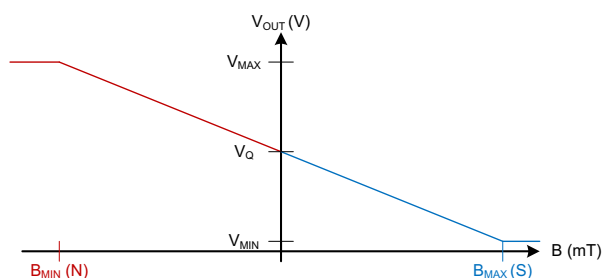
Internal protection functions are provided for reverse supply conditions, load dump, and output short circuit or overcurrent.

Device Information⁽¹⁾

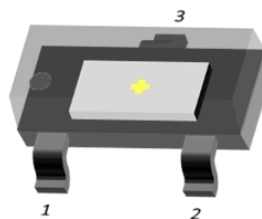
PART NUMBER	PACKAGE	BODY SIZE (NOM)
DRV5053	SOT-23 (3)	2.92 mm \times 1.30 mm
	TO-92 (3)	4.00 mm \times 3.15 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Output State



SOT-23



TO-92

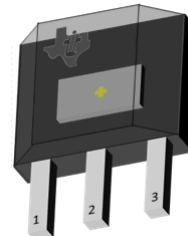


Table of Contents

1 Features	1	7.1 Overview	8
2 Applications	1	7.2 Functional Block Diagram	8
3 Description	1	7.3 Feature Description	9
4 Revision History	2	7.4 Device Functional Modes	11
5 Pin Configuration and Functions	3	8 Application and Implementation	12
6 Specifications	4	8.1 Application Information	12
6.1 Absolute Maximum Ratings	4	8.2 Typical Applications	12
6.2 ESD Ratings	4	9 Power Supply Recommendations	14
6.3 Recommended Operating Conditions	4	10 Device and Documentation Support	15
6.4 Thermal Information	4	10.1 Device Support	15
6.5 Electrical Characteristics	5	10.2 Community Resources	16
6.6 Switching Characteristics	5	10.3 Trademarks	16
6.7 Magnetic Characteristics	5	10.4 Electrostatic Discharge Caution	16
6.8 Typical Characteristics	7	10.5 Glossary	16
7 Detailed Description	8	11 Mechanical, Packaging, and Orderable Information	16

4 Revision History

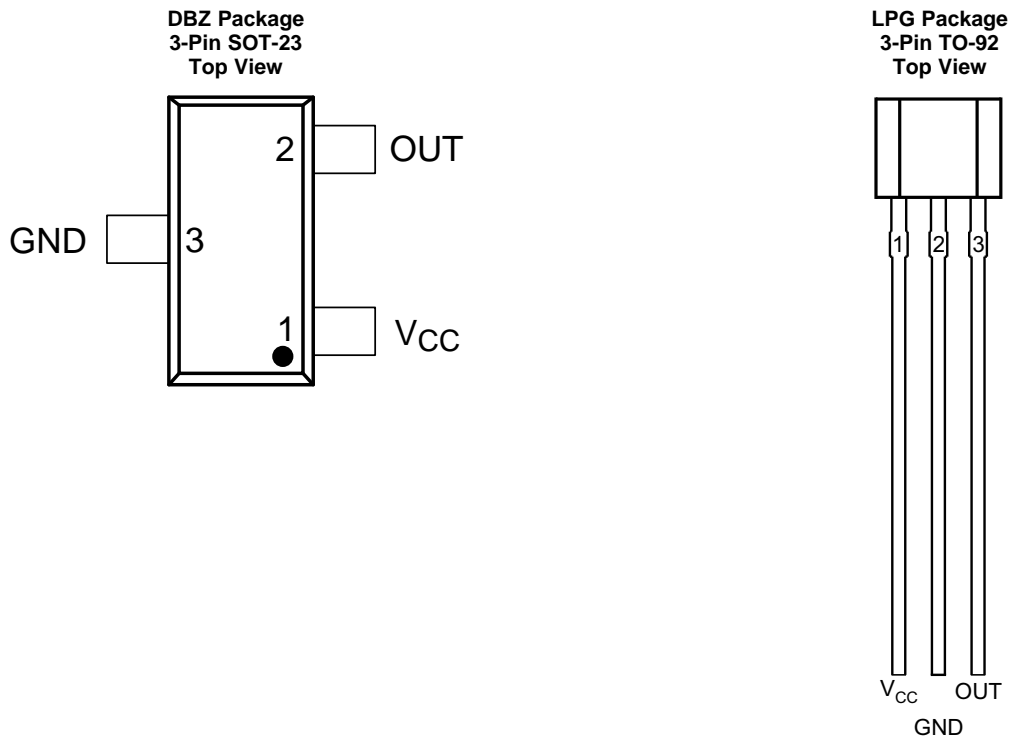
Changes from Revision B (September 2014) to Revision C	Page
• Corrected body size of SOT-23 package and SIP package name to TO-92	1
• Added B _{MAX} to <i>Absolute Maximum Ratings</i>	4
• Removed table note from junction temperature	4
• Updated the typical value for B _N and V _N for each version	5
• Updated Figure 6	7
• Updated the <i>Functional Block Diagram</i>	8
• Updated Output Stage	11
• Updated package tape and reel options for M and blank	15
• Added Community Resources	16

Changes from Revision A (August 2014) to Revision B	Page
• Updated high sensitivity options	1
• Updated the sensitivity device values and typicals. Updated typical and max values for DRV5053VA: –80 mV/mT	6
• Updated <i>Typical Characteristics</i> graphs	7

Changes from Original (May 2014) to Revision A	Page
• Updated device status to production data	1
• Changed the maximum T _J value from 175°C to 150°C	4
• Updated <i>Magnetic Characteristics</i> table.	5

5 Pin Configuration and Functions

For additional configuration information, see [Device Markings](#) and [Mechanical, Packaging, and Orderable Information](#).



Pin Functions

PIN			TYPE	DESCRIPTION
NAME	DBZ	LPG		
GND	3	2	GND	Ground pin
V _{CC}	1	1	Power	2.5 to 38 V power supply. Bypass this pin to the GND pin with a 0.01-μF (minimum) ceramic capacitor rated for V _{CC} .
OUT	2	3	Output	Hall sensor analog output. 1 V output corresponds to B = 0 mT

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

		MIN	MAX	UNIT
Power supply voltage	V_{CC}	–22 ⁽²⁾	40	V
	Voltage ramp rate (V_{CC}), $V_{CC} < 5$ V	Unlimited		V/ μ s
	Voltage ramp rate (V_{CC}), $V_{CC} > 5$ V	0	2	
Output pin voltage		–0.5	2.5	V
Output pin reverse current during reverse supply condition		0	–20	mA
Magnetic flux density, B_{MAX}		Unlimited		
Operating junction temperature, T_J		–40	150	°C
Storage temperature, T_{stg}		–65	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Ensured by design. Only tested to –20 V.

6.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$ Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins ⁽¹⁾		±2500	V
	Charged device model (CDM), per JEDEC specification JESD22-C101, all pins ⁽²⁾		±500	

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V_{CC}	Power supply voltage	2.5	38	V
V_{OUT}	Output pin voltage (OUT)	0	2	V
I_{SOURCE}	Output pin current source (OUT)	0	300	μ A
I_{SINK}	Output pin current sink (OUT)	0	2.3	mA
T_A	Operating ambient temperature	–40	125	°C

6.4 Thermal Information

THERMAL METRIC ⁽¹⁾		DRV5053		UNIT
		DBZ (SOT-23)	LPG (TO-92)	
		3 PINS	3 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	333.2	180	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	99.9	98.6	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	66.9	154.9	°C/W
ψ_{JT}	Junction-to-top characterization parameter	4.9	40	°C/W
ψ_{JB}	Junction-to-board characterization parameter	65.2	154.9	°C/W

- (1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).

6.5 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
POWER SUPPLIES (V_{CC})						
V _{CC}	V _{CC} operating voltage		2.5		38	V
I _{CC}	Operating supply current	V _{CC} = 2.5 to 38 V, T _A = 25°C		2.7		mA
		V _{CC} = 2.5 to 38 V, T _A = 125°C		3	3.6	
t _{on}	Power-on time			35	50	μs
PROTECTION CIRCUITS						
V _{CCR}	Reverse supply voltage		–22			V
I _{OCPSOURCE}	Overcurrent protection level	Sourcing current		300		μA
I _{OCPSINK}	Overcurrent protection level	Sinking current		2.3		mA

6.6 Switching Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
ANALOG OUTPUT (OUT)						
t _d	Output delay time	T _A = 25°C		13	25	μs

6.7 Magnetic Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT ⁽¹⁾
V _Q	Quiescent output	B = 0 mT T _A = –40°C to 125°C	0.9	1.02	1.15	V
f _{BW}	Bandwidth ⁽²⁾		20			kHz
B _N	Input-referred noise ⁽³⁾	C _{OUT} = 50 pF T _A = –40°C to 125°C	0.40	0.49	0.79	mT _{pp}
Le	Linearity ⁽⁴⁾	–B _{SAT} < B < B _{SAT}		1%		
V _{OUT MIN}	Output saturation voltage (min)	B < –B _{SAT}			0.2	V
V _{OUT MAX}	Output saturation voltage (max)	B > B _{SAT}	1.8			V
DRV5053OA: –11 mV/mT						
S	Sensitivity	V _{CC} = 3.3 V T _A ≈ –40°C to 125°C	–17.5	–11	–5	mV/mT
V _N	Output-referred noise	V _{CC} = 3.3 V; R _{OUT} = 10 kΩ; C _{OUT} = 50 pF T _A ≈ –40°C to 125°C		5		mV _{pp}
B _{SAT}	Input saturation field	V _{CC} = 3.3 V T _A ≈ –40°C to 125°C		73		mT
DRV5053PA: –23 mV/mT						
S	Sensitivity	V _{CC} = 3.3 V T _A ≈ –40°C to 125°C	–35	–23	–10	mV/mT
V _N	Output-referred noise	V _{CC} = 3.3 V; R _{OUT} = 10 kΩ; C _{OUT} = 50 pF T _A ≈ –40°C to 125°C		11		mV _{pp}
B _{SAT}	Input saturation field	V _{CC} = 3.3 V T _A ≈ –40°C to 125°C		35		mT

(1) 1 mT = 10 Gauss

(2) Bandwidth describes the fastest changing magnetic field that can be detected and translated to the output.

(3) Not tested in production; limits are based on characterization data.

(4) Linearity describes the change in sensitivity across the B-range. The sensitivity near B_{SAT} is typically within 1% of the sensitivity near B = 0.

DRV5053

SLIS153C –MAY 2014–REVISED DECEMBER 2015

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Magnetic Characteristics (continued)

over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT ⁽¹⁾
DRV5053RA: –45 mV/mT						
S	Sensitivity	$V_{CC} = 3.3\text{ V}$ $T_A \approx -40^\circ\text{C to } 125^\circ\text{C}$	–70	–45	–20	mV/mT
V_N	Output-referred noise	$V_{CC} = 3.3\text{ V}$; $R_{OUT} = 10\text{ k}\Omega$; $C_{OUT} = 50\text{ pF}$ $T_A \approx -40^\circ\text{C to } 125^\circ\text{C}$		22		mV _{pp}
B_{SAT}	Input saturation field	$V_{CC} = 3.3\text{ V}$ $T_A \approx -40^\circ\text{C to } 125^\circ\text{C}$		18		mT
DRV5053VA: –90 mV/mT						
S	Sensitivity	$V_{CC} = 3.3\text{ V}$ $T_A \approx -40^\circ\text{C to } 125^\circ\text{C}$	–140	–90	–45	mV/mT
V_N	Output-referred noise	$V_{CC} = 3.3\text{ V}$; $R_{OUT} = 10\text{ k}\Omega$; $C_{OUT} = 50\text{ pF}$ $T_A \approx -40^\circ\text{C to } 125^\circ\text{C}$		44		mV _{pp}
B_{SAT}	Input saturation field	$V_{CC} = 3.3\text{ V}$ $T_A \approx -40^\circ\text{C to } 125^\circ\text{C}$		9		mT
DRV5053CA: 23 mV/mT						
S	Sensitivity	$V_{CC} = 3.3\text{ V}$ $T_A \approx -40^\circ\text{C to } 125^\circ\text{C}$	10	23	35	mV/mT
V_N	Output-referred noise	$V_{CC} = 3.3\text{ V}$; $R_{OUT} = 10\text{ k}\Omega$; $C_{OUT} = 50\text{ pF}$ $T_A \approx -40^\circ\text{C to } 125^\circ\text{C}$		11		mV _{pp}
B_{SAT}	Input saturation field	$V_{CC} = 3.3\text{ V}$ $T_A \approx -40^\circ\text{C to } 125^\circ\text{C}$		35		mT
DRV5053EA: 45 mV/mT						
S	Sensitivity	$V_{CC} = 3.3\text{ V}$ $T_A \approx -40^\circ\text{C to } 125^\circ\text{C}$	20	45	70	mV/mT
V_N	Output-referred noise	$V_{CC} = 3.3\text{ V}$; $R_{OUT} = 10\text{ k}\Omega$; $C_{OUT} = 50\text{ pF}$ $T_A \approx -40^\circ\text{C to } 125^\circ\text{C}$		22		mV _{pp}
B_{SAT}	Input saturation field	$V_{CC} = 3.3\text{ V}$ $T_A \approx -40^\circ\text{C to } 125^\circ\text{C}$		18		mT

6.8 Typical Characteristics

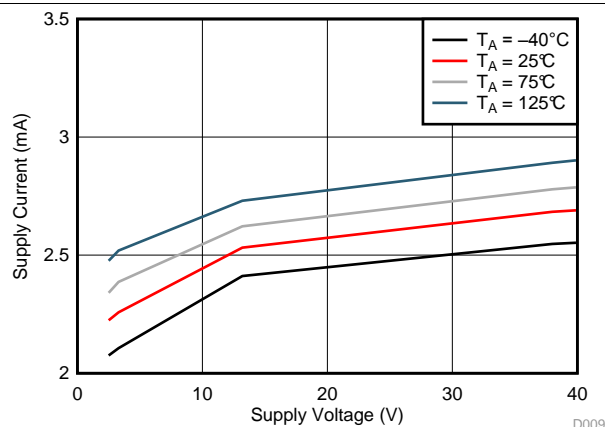


Figure 1. I_{CC} vs V_{CC}

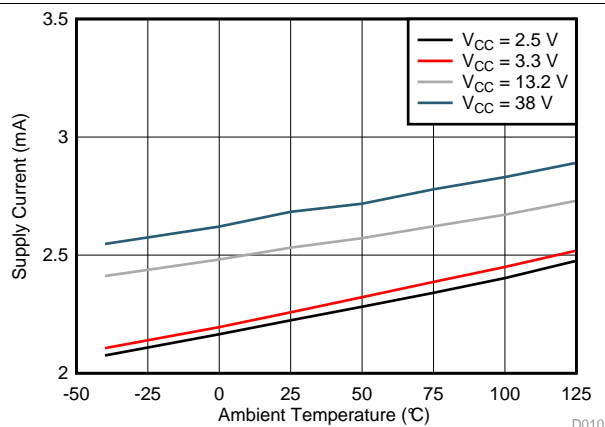


Figure 2. I_{CC} vs Temperature

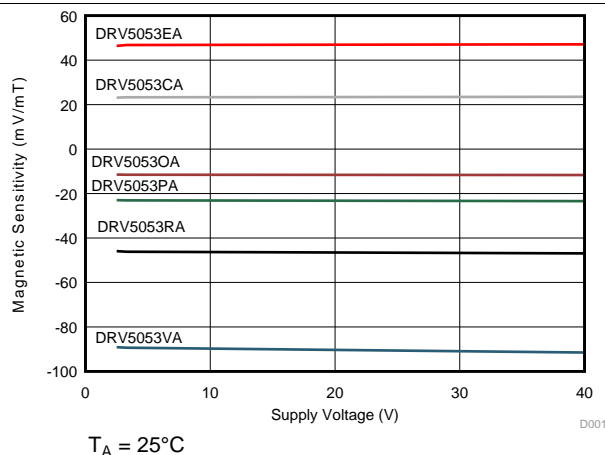


Figure 3. Sensitivity vs V_{CC}

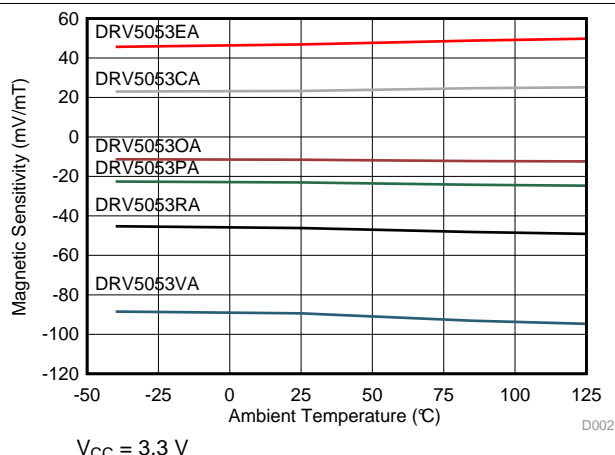


Figure 4. Sensitivity vs Temperature

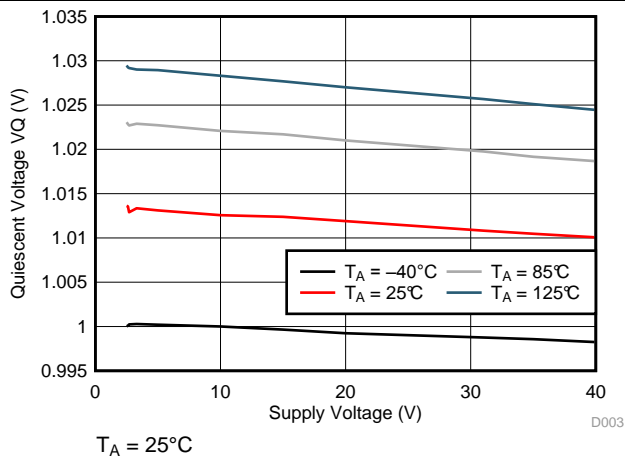


Figure 5. V_Q vs V_{CC}

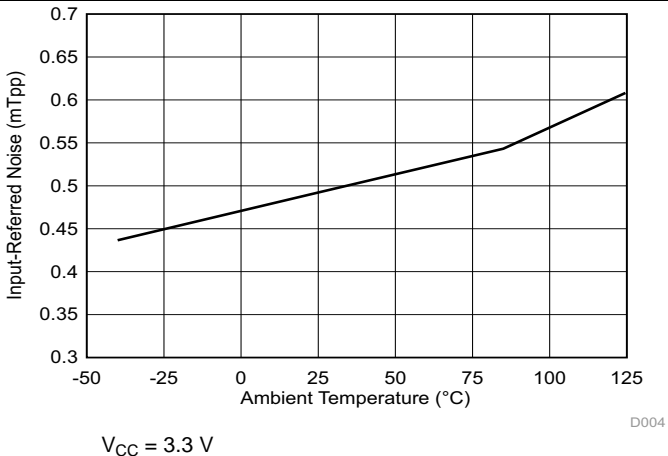


Figure 6. B_N vs Temperature

7 Detailed Description

7.1 Overview

The DRV5053 device is a chopper-stabilized Hall sensor with an analog output for magnetic sensing applications. The DRV5053 device can be powered with a supply voltage between 2.5 and 38 V, and will survive –22 V reverse battery conditions continuously. Note that the DRV5053 device will not be operating when approximately –22 to 2.4 V is applied to V_{CC} (with respect to GND). In addition, the device can withstand supply voltages up to 40 V for transient durations.

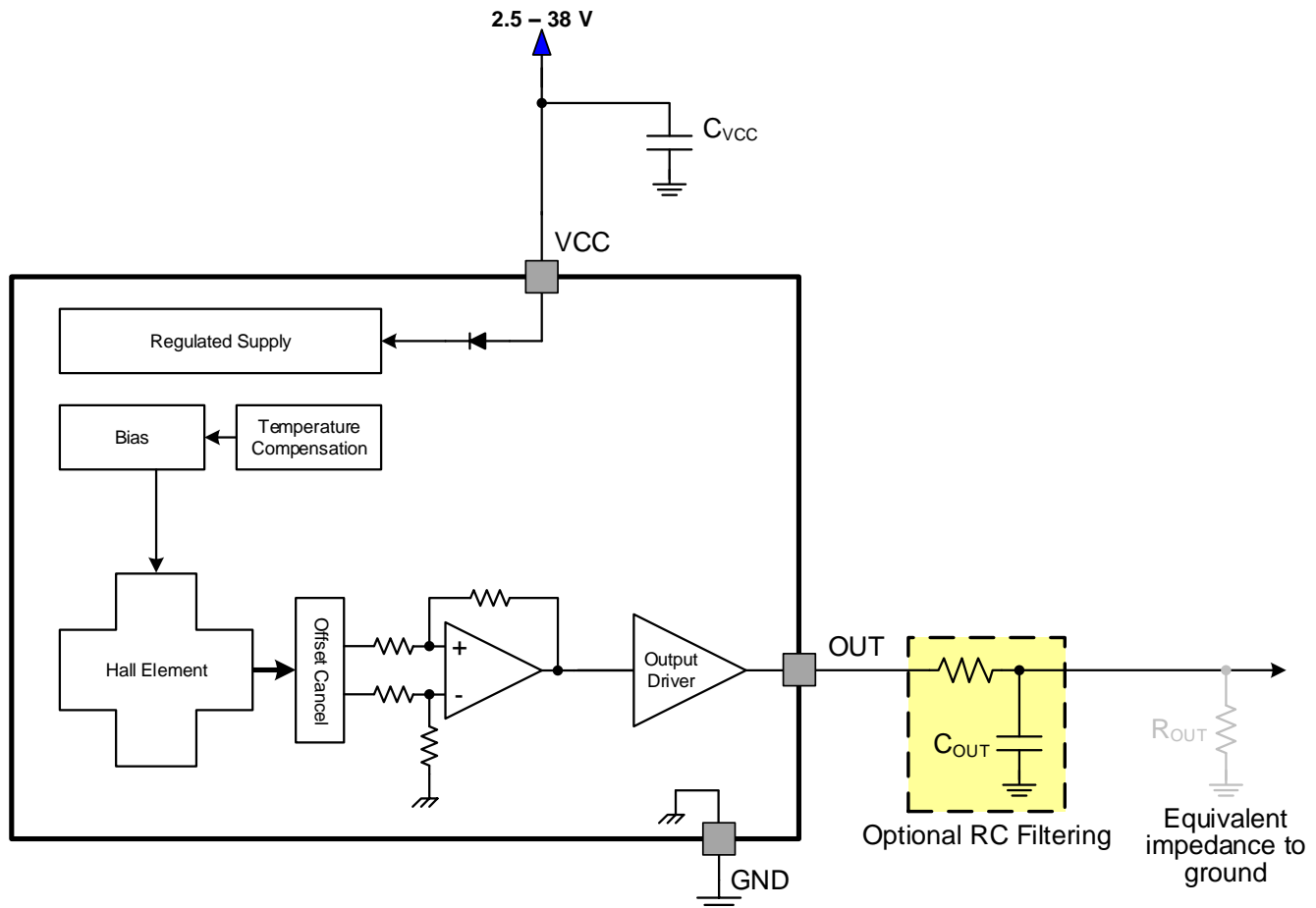
The output voltage is dependent on the magnetic field perpendicular to the package. The absence of a magnetic field will result in $OUT = 1\text{ V}$. A magnetic field will cause the output voltage to change linearly with the magnetic field.

The field polarity is defined as follows: a **south pole** near the marked side of the package is a positive magnetic field. A **north pole** near the marked side of the package is a negative magnetic field.

For devices with a negative sensitivity (that is, DRV5053RA: –40 mV/mT), a **south pole** will cause the output voltage to drop below 1 V, and a north pole will cause the output to rise above 1 V.

For devices with a positive sensitivity (that is, DRV5053EA: +40 mV/mT), a **south pole** will cause the output voltage to rise above 1 V, and a north pole will cause the output to drop below 1 V.

7.2 Functional Block Diagram



7.3 Feature Description

7.3.1 Field Direction Definition

A positive magnetic field is defined as a **south pole** near the marked side of the package as shown in [Figure 7](#).

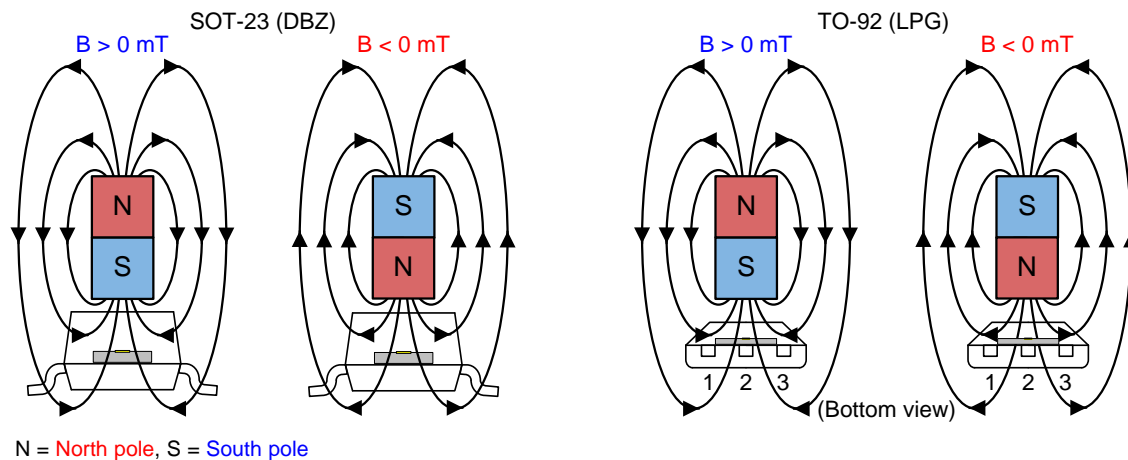


Figure 7. Field Direction Definition

7.3.2 Device Output

The DRV5053 device output is defined below for negative sensitivity (that is, -45 mV/mT , RA) and positive sensitivity (that is, $+45 \text{ mV/mT}$, EA):

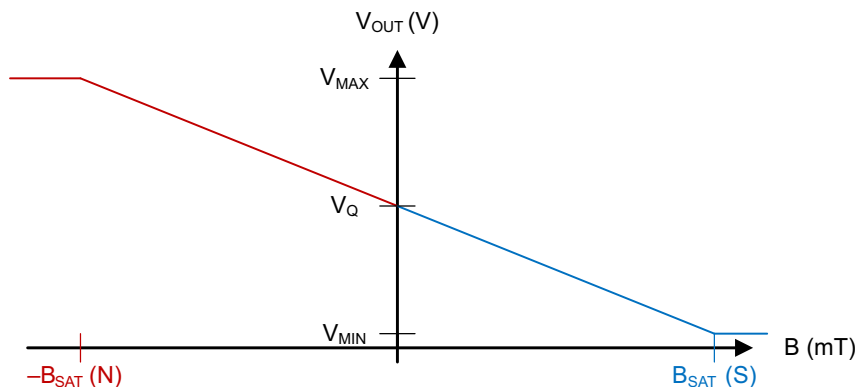


Figure 8. DRV5053 – Negative Sensitivity

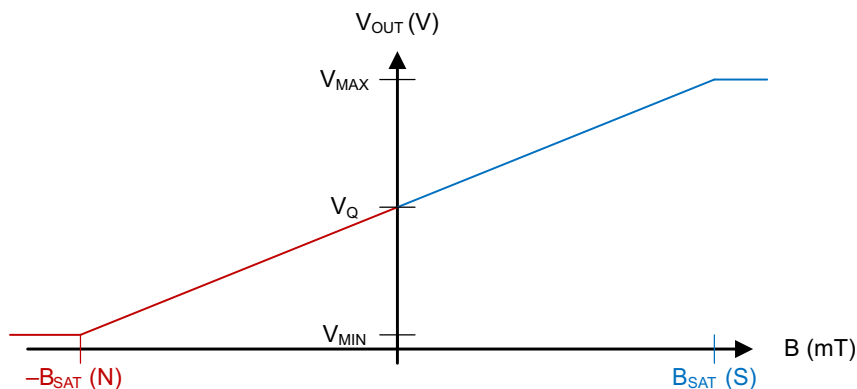


Figure 9. DRV5053 – Positive Sensitivity

Feature Description (continued)

7.3.3 Power-On Time

After applying V_{CC} to the DRV5053 device, t_{on} must elapse before OUT is valid. Figure 10 shows Case 1 and Figure 11 shows case 2; the output is defined assuming a negative sensitivity device and a constant magnetic field $-B_{SAT} < B < B_{SAT}$.

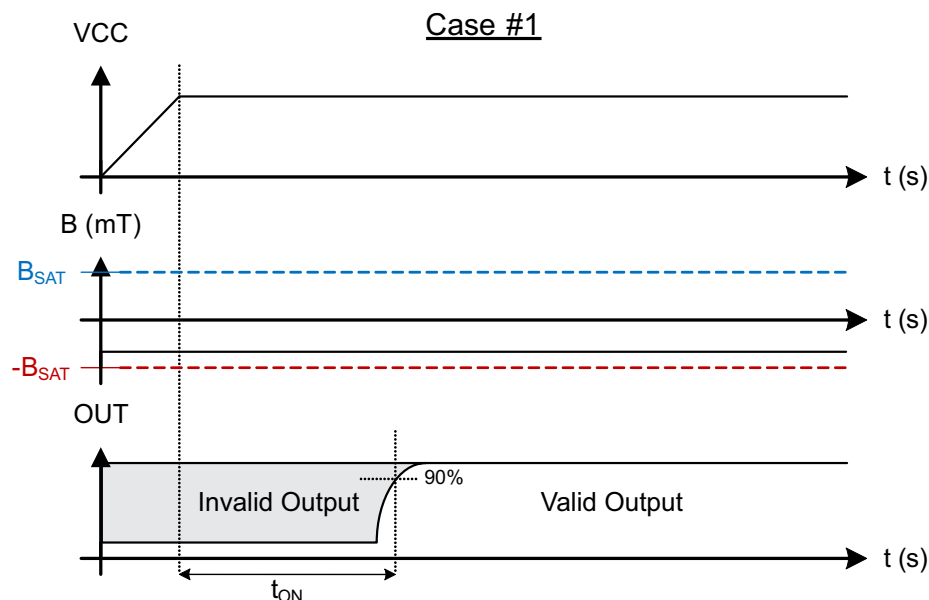


Figure 10. Case 1: Power On When $B < 0$, North

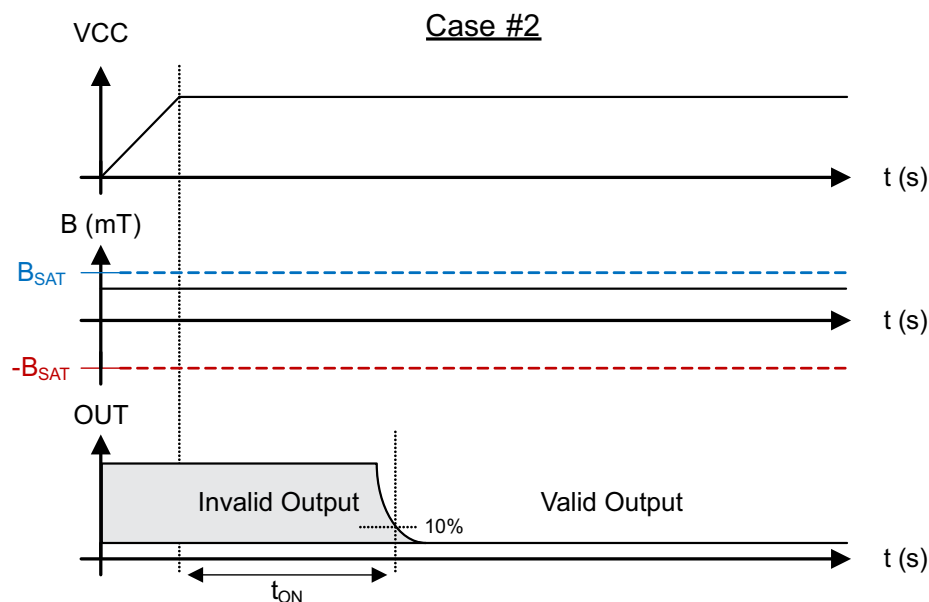


Figure 11. Case 2: Power On When $B > 0$, South

Feature Description (continued)

7.3.4 Output Stage

The DRV5053 output stage is capable of up to 300- μ A of current source or 2.3-mA sink. For proper operation, ensure that equivalent output load $R_{OUT} > 10\text{ k}\Omega$.

The capacitive load directly present on the OUT pin should be less than 10 nF to ensure the internal operational amplifier is stable. If an external RC filter is added to reduce noise, it is acceptable to use a resistor $\geq 200\text{ }\Omega$ with a capacitor $\leq 0.1\text{ }\mu\text{F}$. For an application example, see [Filtered Typical Application](#).

7.3.5 Protection Circuits

An analog current limit circuit limits the current through the output driver. The driver current will be clamped to I_{OCP} .

7.3.5.1 Overcurrent Protection (OCP)

An analog current-limit circuit limits the current through the FET. The driver current is clamped to I_{OCP} . During this clamping, the $r_{DS(on)}$ of the output FET is increased from the nominal value.

7.3.5.2 Load Dump Protection

The DRV5053 device operates at DC V_{CC} conditions up to 38 V nominally, and can additionally withstand $V_{CC} = 40\text{ V}$. No current-limiting series resistor is required for this protection.

7.3.5.3 Reverse Supply Protection

The DRV5053 device is protected in the event that the V_{CC} pin and the GND pin are reversed (up to -22 V).

NOTE

In a reverse supply condition, the OUT pin reverse-current must not exceed the ratings specified in the [Absolute Maximum Ratings](#).

Table 1.

FAULT	CONDITION	DEVICE	DESCRIPTION	RECOVERY
FET overload (OCP)	$I_{SINK} \geq I_{OCP}$	Operating	Output current is clamped to I_{OCP}	$I_O < I_{OCP}$
Load Dump	$38\text{ V} < V_{CC} < 40\text{ V}$	Operating	Device will operate for a transient duration	$V_{CC} \leq 38\text{ V}$
Reverse Supply	$-22\text{ V} < V_{CC} < 0\text{ V}$	Disabled	Device will survive this condition	$V_{CC} \geq 2.5\text{ V}$

7.4 Device Functional Modes

The DRV5053 device is active only when V_{CC} is between 2.5 and 38 V.

When a reverse supply condition exists, the device is inactive.

8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

The DRV5053 device is used in magnetic-field sensing applications.

8.2 Typical Applications

8.2.1 Typical Application With No Filter

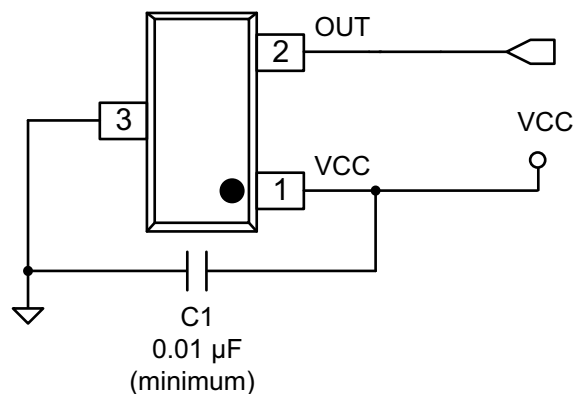


Figure 12. Typical Application Schematic – No Filter

8.2.1.1 Design Requirements

For this design example, use the parameters listed in [Table 2](#) as the input parameters.

Table 2. Design Parameters

DESIGN PARAMETER	REFERENCE	EXAMPLE VALUE
System bandwidth	f_{BW}	15 kHz

8.2.1.2 Detailed Design Procedure

The DRV5053 has internal filtering that limits the bandwidth to at least 20 kHz. For this application no external components are required other than the C1 bypass capacitor, which is 0.01 μ F minimum. If the analog output OUT is tied to a microcontroller ADC input, the equivalent load must be $R > 10$ k Ω and $C < 10$ nF.

Table 3. External Components

COMPONENT	PIN 1	PIN 2	RECOMMENDED
C1	V _{CC}	GND	A 0.01- μ F (minimum) ceramic capacitor rated for V _{CC}

8.2.1.3 Application Curve

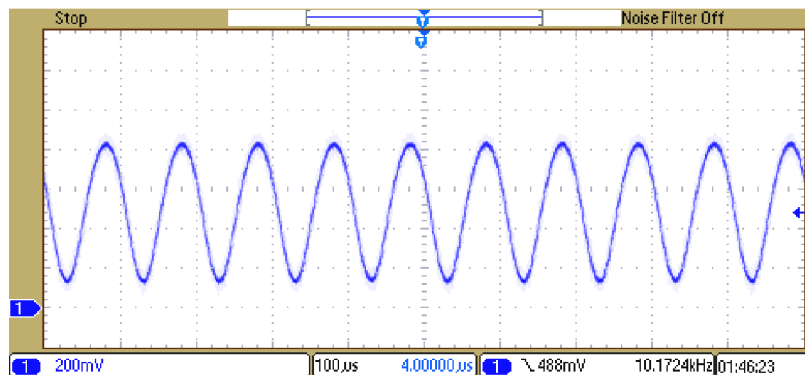


Figure 13. 10-kHz Switching Magnetic Field

8.2.2 Filtered Typical Application

For lower noise on the analog output OUT, additional RC filtering can be added to further reduce the bandwidth.

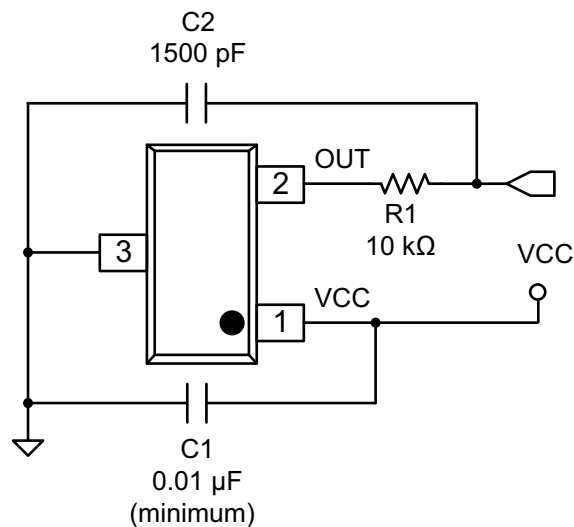


Figure 14. Filtered Typical Application Schematic

8.2.2.1 Design Requirements

For this design example, use the parameters listed in [Table 4](#) as the input parameters.

Table 4. Design Parameters

DESIGN PARAMETER	REFERENCE	EXAMPLE VALUE
System bandwidth	f_{BW}	5 kHz

8.2.2.2 Detailed Design Procedure

In this example we will add an external RC filter in order to reduce the output bandwidth.

In order to preserve the signal at the frequencies of interest, we will conservatively select a low-pass filter bandwidth (–3-dB point) at twice the system bandwidth (10 kHz).

$$10 \text{ kHz} < \frac{1}{2\pi \times R_1 \times C_2} \quad (1)$$

If we guess $R_1 = 10 \text{ k}\Omega$, then $C_2 < 1590 \text{ pF}$. So we select $C_2 = 1500 \text{ pF}$.

8.2.2.2.1 Typical Noise Versus Cutoff Frequency

RC filters are an effective way to reduce the noise present on OUT. The following shows typical noise measurements for different cutoff frequencies using the DRV5053VA.

Table 5. DRV5053VA Typical Noise Data

R (Ω)	C (μF)	f _{CUTOFF} (kHz)	NOISE (mVpp)
163	0.1	9.8	30.4
349	0.1	4.6	22.8
750	0.1	2.1	15.2
1505	0.1	1.1	9.7
3322	0.1	0.5	5.3
7510	0.1	0.2	2.5

8.2.2.3 Application Curves

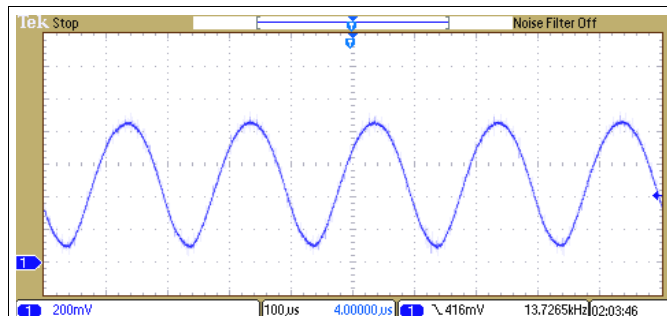


Figure 15. 5-kHz Switching Magnetic Field

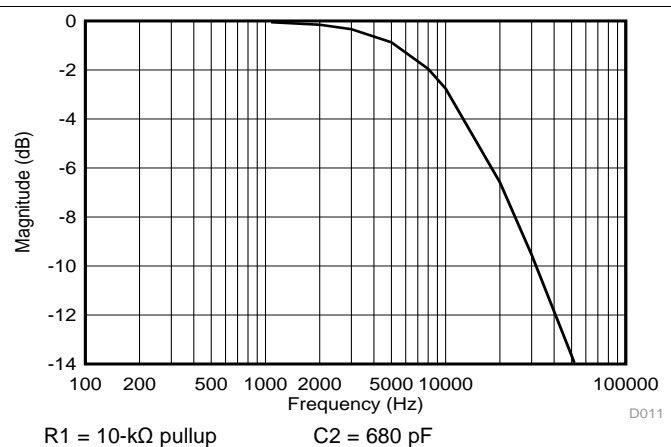


Figure 16. Low-Pass Filtering

9 Power Supply Recommendations

The DRV5053 device is designed to operate from an input voltage supply (VM) range between 2.5 and 38 V. A 0.01-μF (minimum) ceramic capacitor rated for V_{CC} must be placed as close to the DRV5053 device as possible.

10 Device and Documentation Support

10.1 Device Support

10.1.1 Device Nomenclature

Figure 17 shows a legend for reading the complete device name for and DRV5053 device.

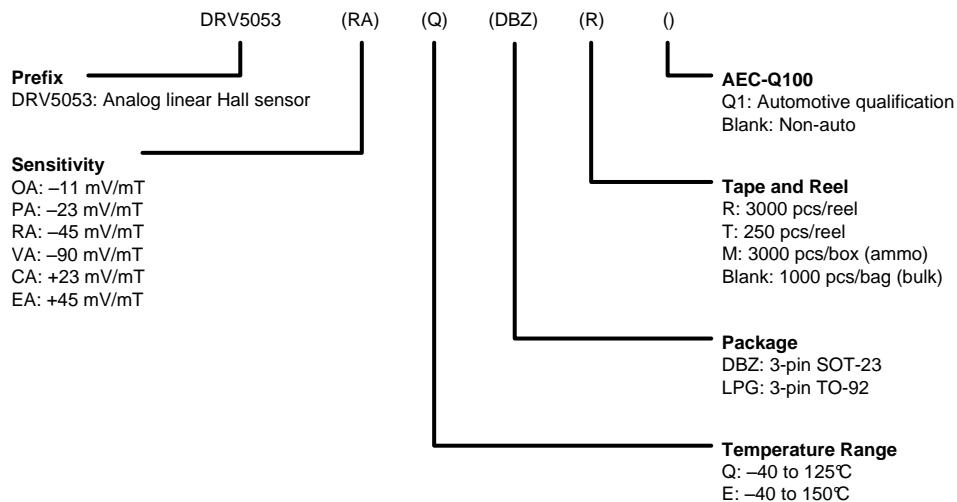


Figure 17. Device Nomenclature

10.1.2 Device Markings

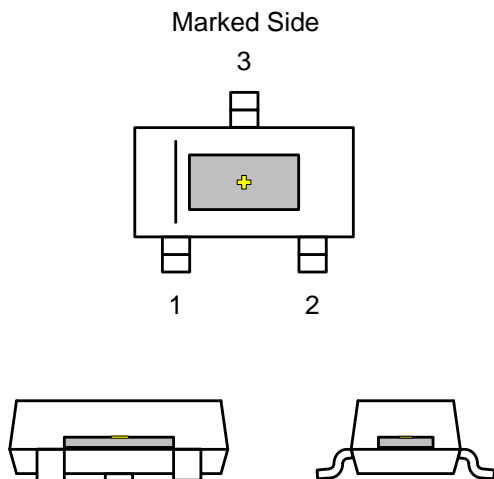


Figure 18. SOT-23 (DBZ) Package

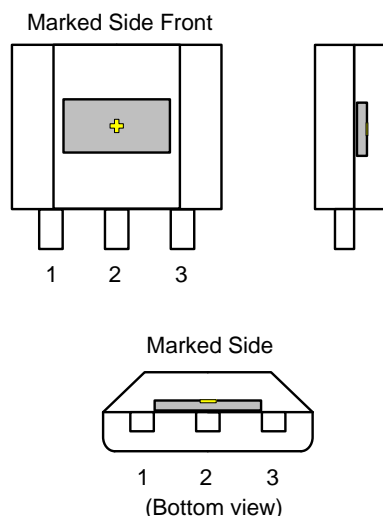


Figure 19. TO-92 (LPG) Package

✚ indicates the Hall effect sensor (not to scale). The Hall element is located in the center of the package with a tolerance of $\pm 100 \mu\text{m}$. The height of the Hall element from the bottom of the package is $0.7 \text{ mm} \pm 50 \mu\text{m}$ in the DBZ package and $0.987 \text{ mm} \pm 50 \mu\text{m}$ in the LPG package.

10.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

10.3 Trademarks

E2E is a trademark of Texas Instruments.
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10.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

10.5 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
DRV5053CAQDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALCA	Samples
DRV5053CAQDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALCA	Samples
DRV5053CAQLPG	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALCA	Samples
DRV5053CAQLPGM	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALCA	Samples
DRV5053EAQDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALEA	Samples
DRV5053EAQDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALEA	Samples
DRV5053EAQLPG	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALEA	Samples
DRV5053EAQLPGM	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALEA	Samples
DRV5053OAQDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALOA	Samples
DRV5053OAQDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALOA	Samples
DRV5053OAQLPG	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALOA	Samples
DRV5053OAQLPGM	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALOA	Samples
DRV5053PAQDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALPA	Samples
DRV5053PAQDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALPA	Samples
DRV5053PAQLPG	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALPA	Samples
DRV5053PAQLPGM	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALPA	Samples
DRV5053RAQDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALRA	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
DRV5053RAQDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALRA	Samples
DRV5053RAQLPG	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALRA	Samples
DRV5053RAQLPGM	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALRA	Samples
DRV5053VAQDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALVA	Samples
DRV5053VAQDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALVA	Samples
DRV5053VAQLPG	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALVA	Samples
DRV5053VAQLPGM	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALVA	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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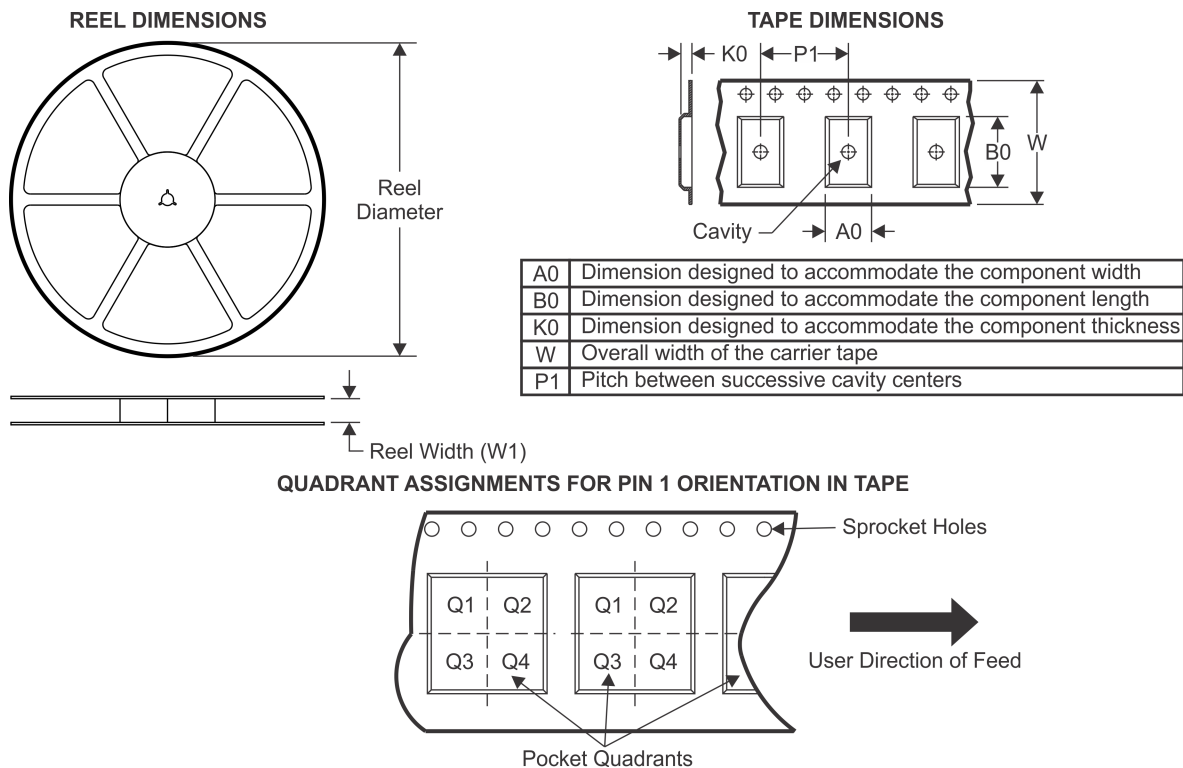
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OTHER QUALIFIED VERSIONS OF DRV5053 :

- Automotive: [DRV5053-Q1](#)

NOTE: Qualified Version Definitions:

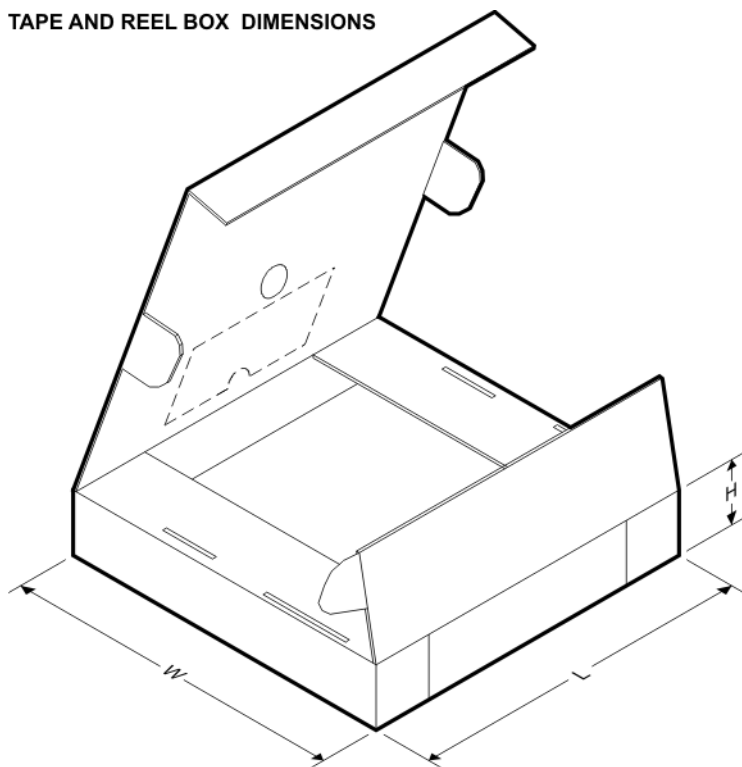
- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

TAPE AND REEL INFORMATION


*All dimensions are nominal

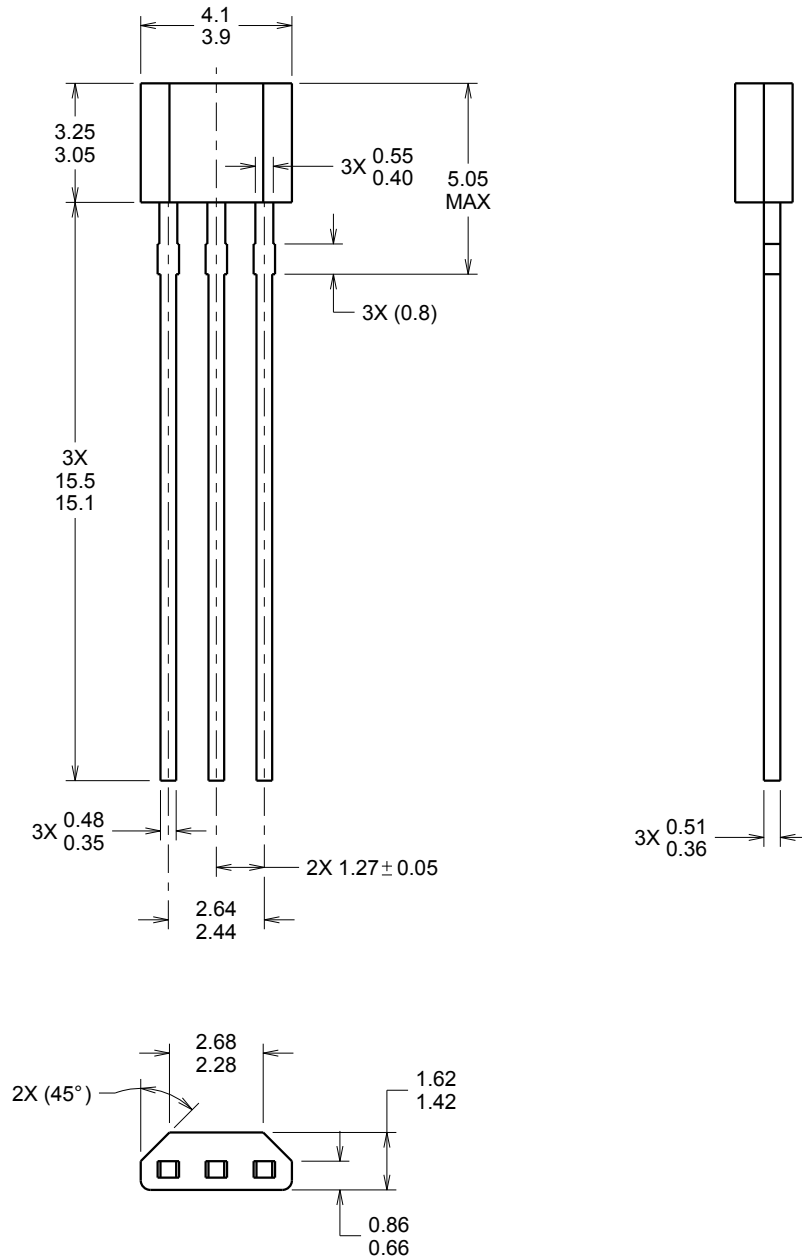
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
DRV5053CAQDBZR	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053CAQDBZT	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053EAQDBZR	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053EAQDBZT	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053OAQDBZR	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053OAQDBZT	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053PAQDBZR	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053PAQDBZT	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053RAQDBZR	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053RAQDBZT	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053VAQDBZR	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053VAQDBZT	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
DRV5053CAQDBZR	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053CAQDBZT	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053EAQDBZR	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053EAQDBZT	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053OAQDBZR	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053OAQDBZT	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053PAQDBZR	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053PAQDBZT	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053RAQDBZR	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053RAQDBZT	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053VAQDBZR	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053VAQDBZT	SOT-23	DBZ	3	250	202.0	201.0	28.0



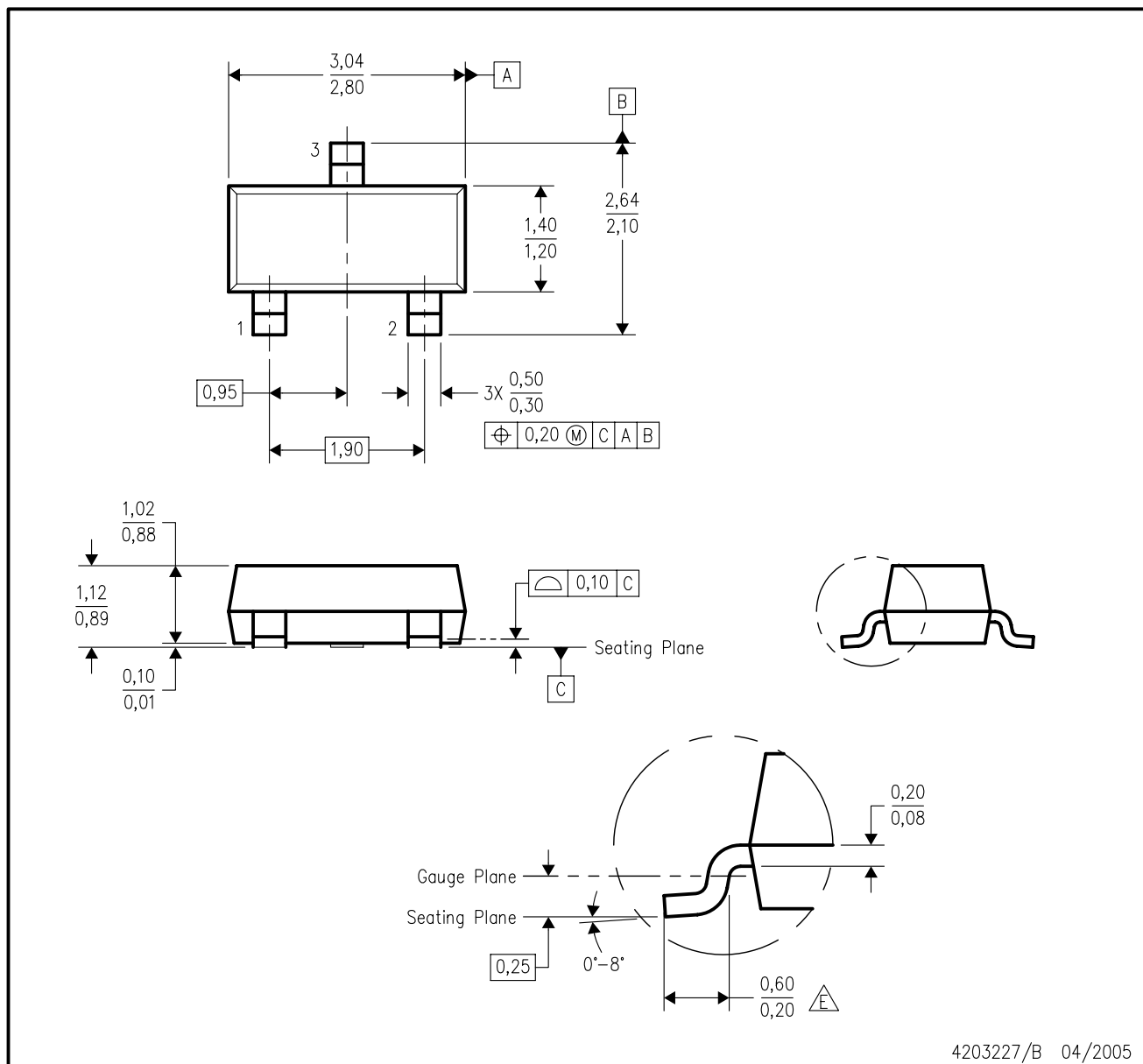
4221343/A 02/2014

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

DBZ (R-PDSO-G3)

PLASTIC SMALL-OUTLINE



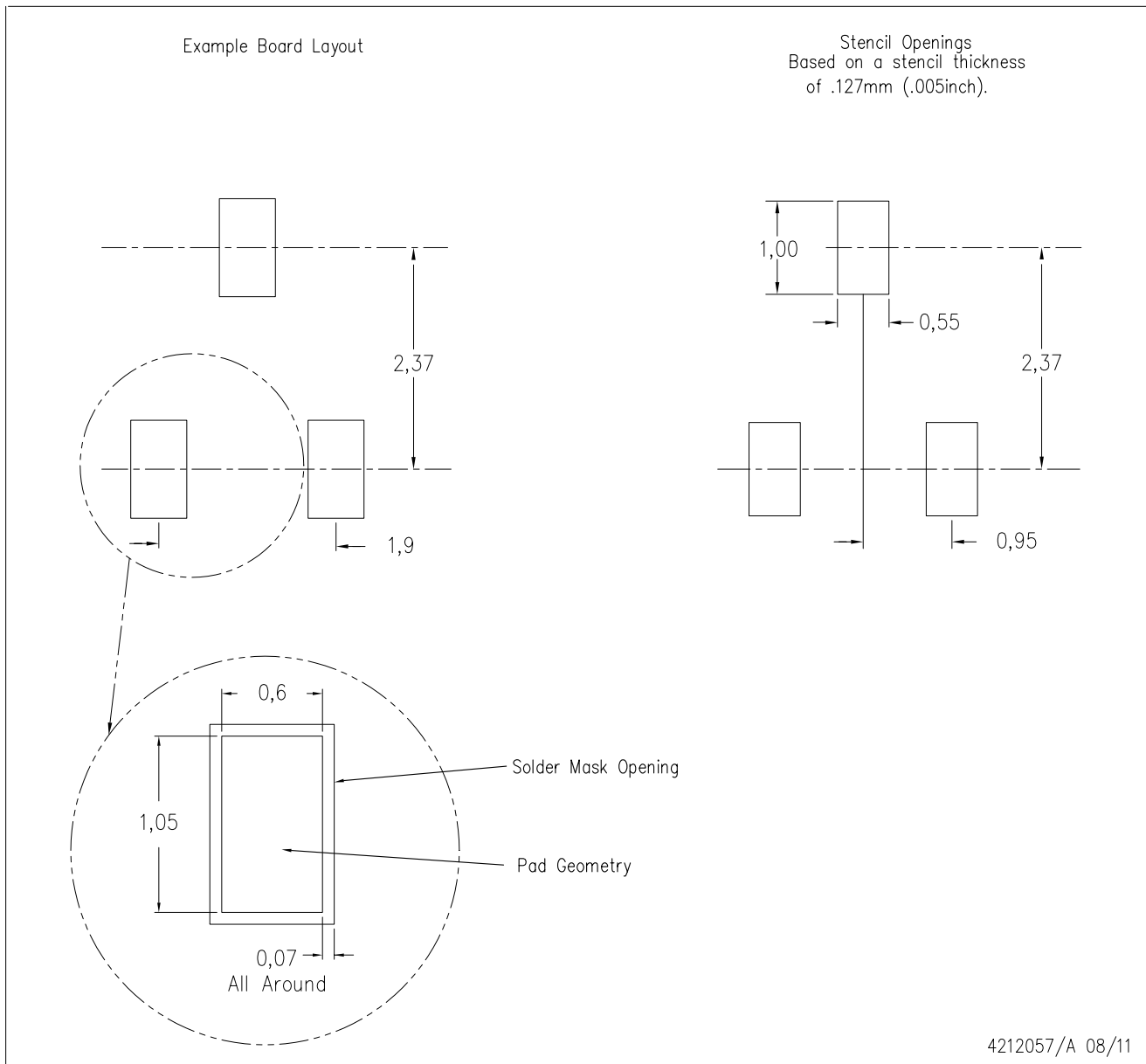
4203227/B 04/2005

NOTES:

- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
- B. This drawing is subject to change without notice.
- C. Lead dimensions are inclusive of plating.
- D. Body dimensions are exclusive of mold flash and protrusion. Mold flash and protrusion not to exceed 0.25 per side.
- E. Falls within JEDEC TO-236 variation AB, except minimum foot length.

DBZ (R-PDSO-G3)

PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
 - Publication IPC-7351 is recommended for alternate designs.
 - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.

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